FAIRCHILD

SEMICONDUCTOR®

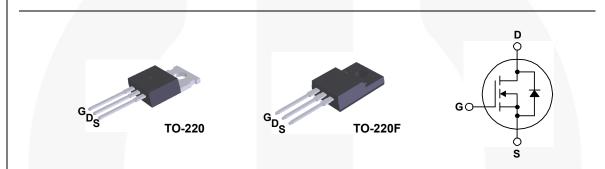
FQP9N90C / FQPF9N90C **N-Channel QFET® MOSFET** 900 V, 8.0 A, 1.4 Ω

Description

This N-Channel enhancement mode power MOSFET is • 8 A, 900 V, R_{DS(on)} = 1.4 Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 45 nC) resistance, and to provide superior switching performance . Low Crss (Typ. 14 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- $I_D = 4 A$



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

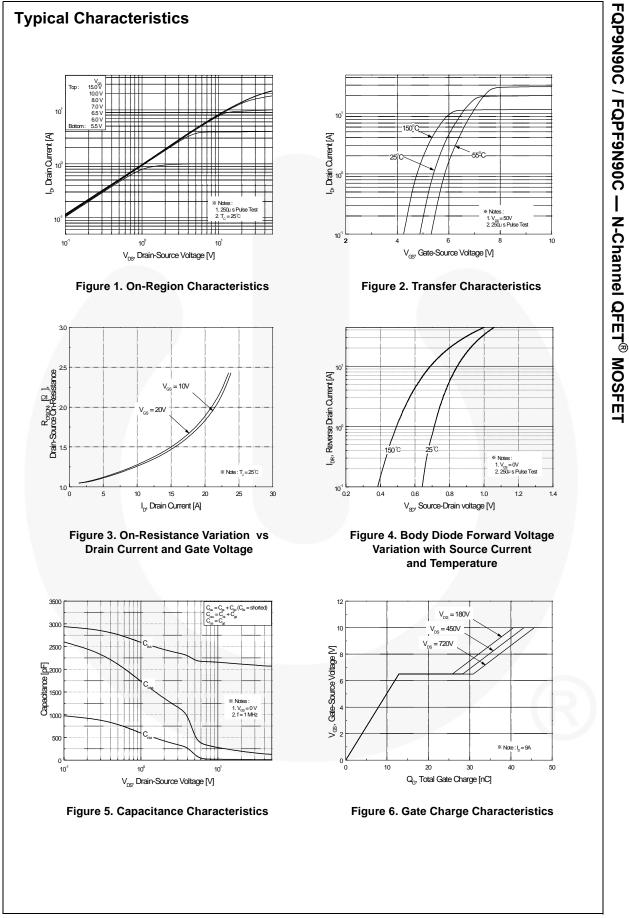
Symbol	Parameter		FQP9N90C FQPF9N90CT		Unit
V _{DSS}	Drain-Source Voltage	g	V		
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		8.0	8.0 *	А
	- Continuous (T _C = 100°C)	-	2.8	2.8 *	А
DM	Drain Current - Pulsed	(Note 1)	32	32 *	А
V _{GSS}	Gate-Source Voltage	±	V		
E _{AS}	Single Pulsed Avalanche Energy (Note 2		9	mJ	
AR	Avalanche Current	(Note 1)	8.0		А
E _{AR}	Repetitive Avalanche Energy (Note		2	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0		V/ns
P _D	Power Dissipation ($T_C = 25^{\circ}C$)	205	68	W	
	- Derate above 25°C	1.64	0.54	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 te	°C		
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds	3	°C		

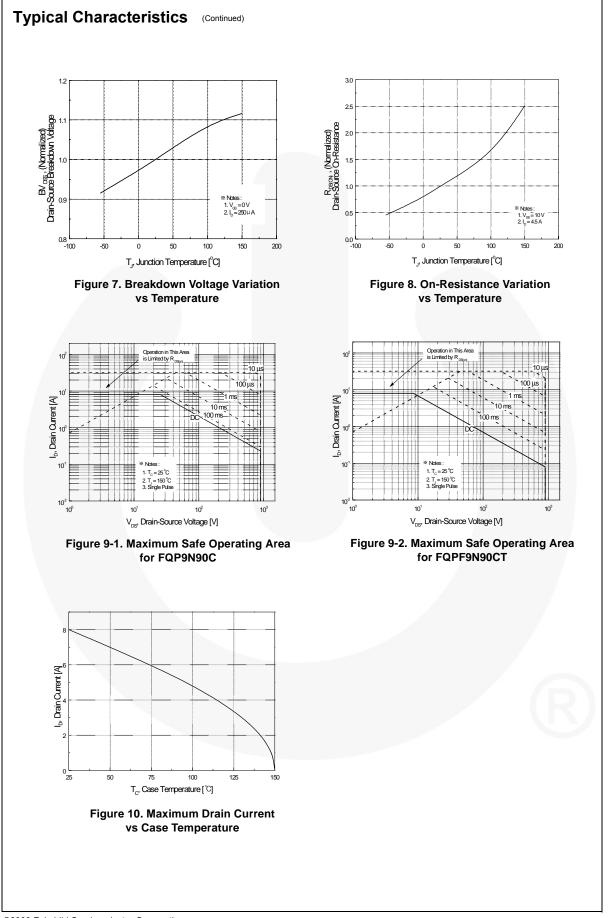
* Drain current limited by maximum junction temperature

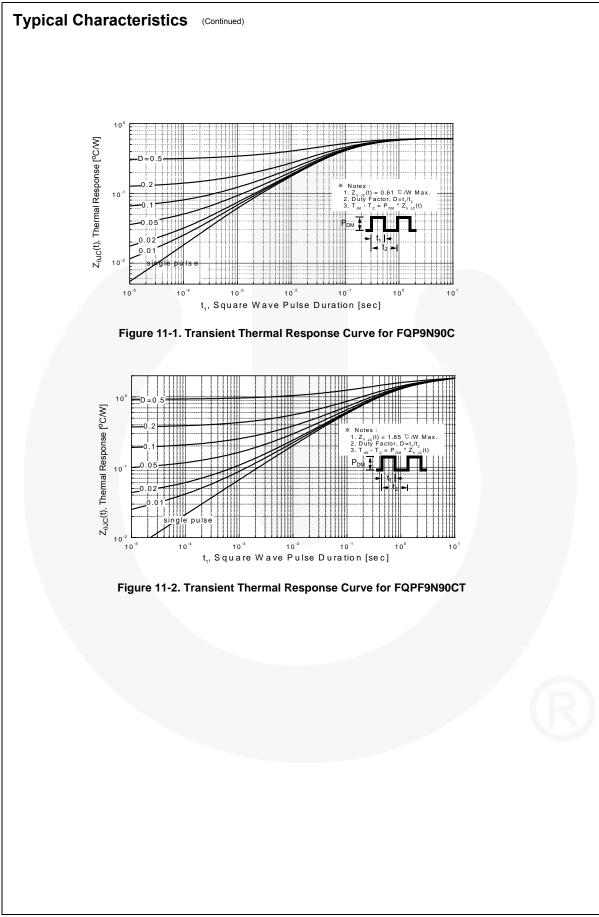
Thermal Characteristics

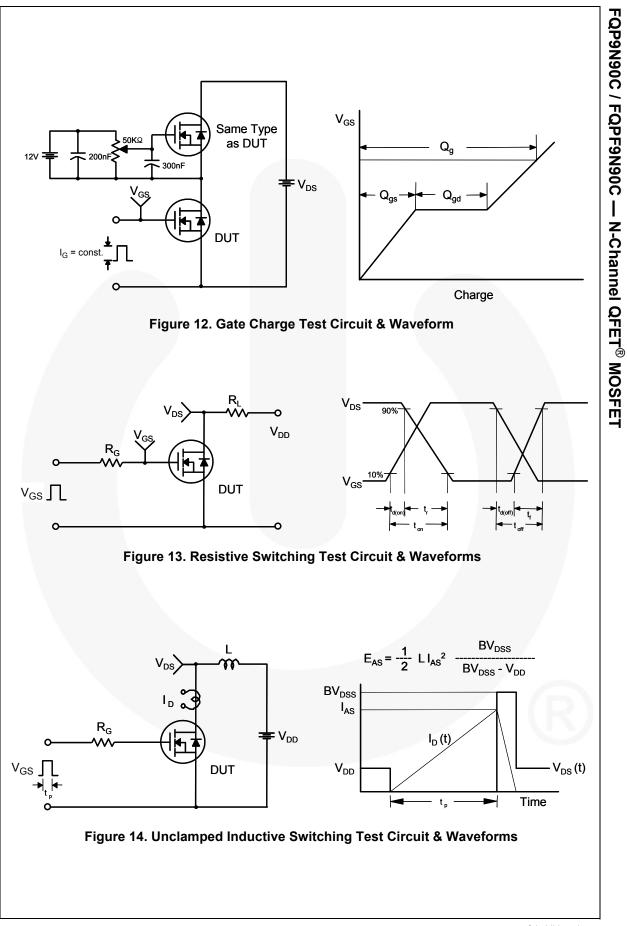
Symbol	Parameter	FQP9N90C	FQPF9N90CT	Unit °C/W	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.61	1.85		
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ, Max.	0.5		°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

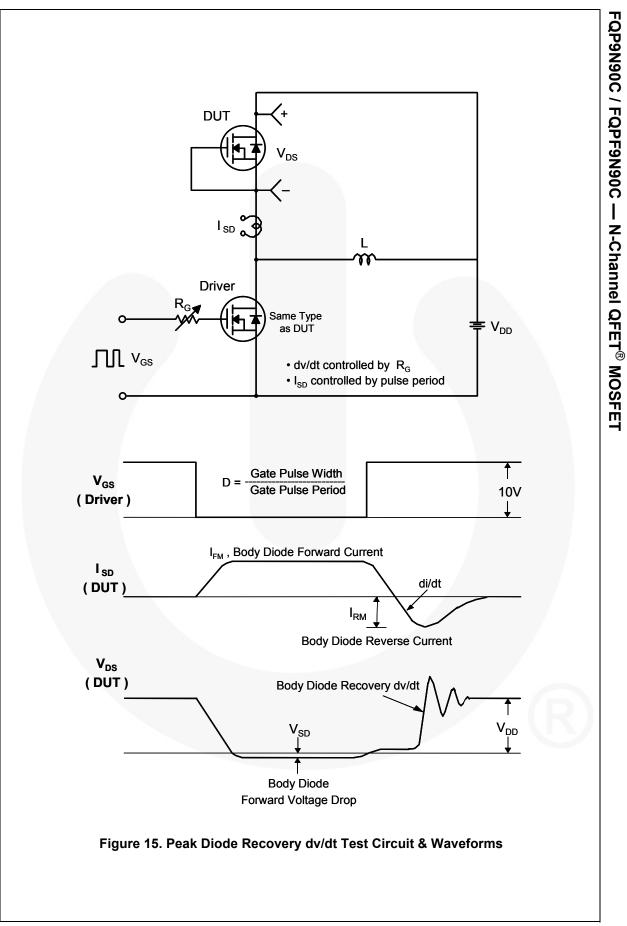
-		Top Mark	Package		Packing Method Reel		Size	Tape Width N/A		Quantity 50 units	
		FQP9N90C	TO-2	220 Tube N/A		ł					
		20F Tube N/		Ą	N/A		50 units				
	al Cha	racteristics	T _C = 25°C	unless ot	herwise noted.			-		1	
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit	
Off Cha	racteris	tics									
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250 μA		900			V			
BV _{DSS}	Breakdown Voltage Temperature										
$/\Delta T_J$	Coefficier	o		$I_D = 250 \ \mu$ A, Referenced to 25°C				0.99		V/°C	
DSS	1			V _{DS} = 900 V, V _{GS} = 0 V				10	μA		
200	Zero Gate Voltage Drain Current		V _{DS} = 720 V, T _C = 125°C					10	μA		
GSSF	Gate-Bod	Gate-Body Leakage Current, Forward		V _{GS} = 30 V, V _{DS} = 0 V					100	nA	
GSSR		Gate-Body Leakage Current, Reverse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$					-100	nA	
		••••									
Jn Cna / _{GS(th)}	Gate Thre	eshold Voltage	-	Vpe =	• V _{GS} , I _D = 250 μA		3.0		5.0	V	
RDS(on)	Static Dra	iin-Source	-	_	= 10 V, I _D = 4 A			1.12	1.4	Ω	
		On-Resistance Forward Transconductance		V _{DS} = 40 V, I _D = 4 A				9.2		S	
IFS	1 of Ward		_	103				0.2			
-	ic Chara	cteristics								-	
Piss	Input Cap	acitance	_	V _{DS} =	= 25 V, V _{GS} = 0 V,	= 0 V,		2100	2730	pF	
Soss	Output Ca	Capacitance		f = 1.0 MHz				175	230	pF	
Srss	Reverse	Transfer Capacitance	9				14	18	pF		
Switchi	ng Char	acteristics									
d(on)	Turn-On I	-On Delay Time					50	110	ns		
	Turn-On I	Rise Time			$V_{DD} = 450 \text{ V}, \text{ I}_{D} = 9.0 \text{ A},$ R _G = 25 Ω			120	250	ns	
d(off)	Turn-Off I	Delay Time		NG -	20 32			100	210	ns	
:	Turn-Off I	all Time				(Note 4)		75	160	ns	
λ _g	Total Gate	e Charge		V _{De} =	= 720 V, I _D = 9.0A,			45	58	nC	
λ _{gs}		rce Charge		V _{GS} =				13		nC	
λ _{gd}	Gate-Dra	-				(Note 4)		18		nC	
										/	
Drain-S	ource D	iode Characteri	stics ar	nd Ma	ximum Ratings						
S	Maximum	Continuous Drain-S	ource Dic	de For	ward Current				8.0	А	
SM	Maximum	Pulsed Drain-Sourc	e Diode F	orward	Current				32.0	Α	
/ _{SD}	Drain-Sou	urce Diode Forward	/oltage		= 0 V, I _S = 8 A				1.4	V	
rr	Reverse I	Recovery Time			= 0 V, I _S = 9 A,			550		ns	
۲ ^ر	Reverse	Recovery Charge		dl _F / c	lt = 100 Α/μs			6.5		μC	
otes: Repetitive ra	ating : pulse-wi	dth limited by maximum jun	ction temper	ature.						0	

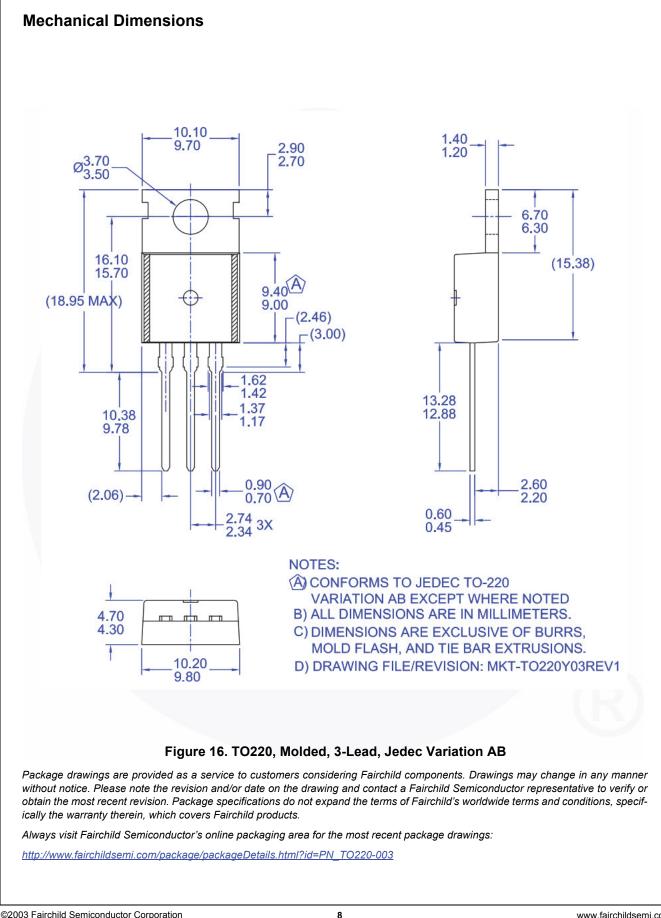


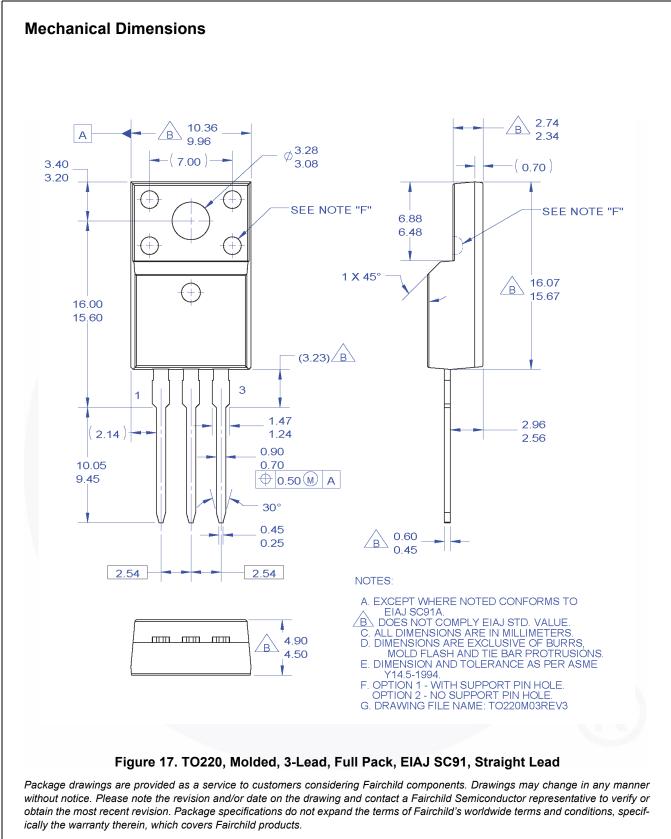












Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF220-003

FQP9N90C / FQPF9N90C ---

N-Channel QFET[®] MOSFET



Rev. 166

Preliminary

No Identification Needed

Obsolete

First Production

Full Production

Not In Production

notice to improve design.

Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.

Datasheet contains specifications on a product that is discontinued by Fairchild

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